

## Black Flexible Epoxy, Encapsulating & Potting Compound

834FX is a 2-part, flame-retardant, thermally conductive, fexible epoxy resin that provides extreme environmental, mechanical and physical protection for printed circuit boards and electronic assemblies.

This product is designed for applications where minimizing the physical stress on components is critical. It is good in low temperature and arctic environments, and in applications that involve temperature cycling or rapid temperature changes. It provides the functionality of silicone, but with the durability and cost-effectiveness of epoxy.

#### **Features & Benefits**

Flexible and low modulus

Flame-retardant—meets UL 94V-0

Convenient 1A:1B volume mix ratio

Low exotherm

Good adhesion to a wide variety of substrates including metals, composites, glass, ceramics, and many plastics

**Excellent electrical insulating characteristics** 

Non-halogenated flame-retardant fillers

Solvent-free

#### **Cure Instructions**

Allow to cure at room temperature for 48 hours, or cure in an oven at one of these time/temperature options:

Temperature	65 °C	80°C	100°C
Time	2 h	1 h	30 mir



### **Available Packaging**

Part #	Packaging	Net Vol.	Net Wt.
834FX-1.7L	2 Can kit	1.7 L	2.75 kg
834FX-40L	2 Pail kit	40 L	64.7 kg

### **Storage and Handling**

Store between 16 and 27  $^{\circ}$ C in a dry area, away from sunlight (see SDS). Storage below 16  $^{\circ}$ C can result in crystallization.



## **Liquid Properties**

Chemistry	Ероху	_
Density	1.6 g/mL (Mixed) 1.6 g/mL (A) 1.6 g/mL (B)	ASTM D1475
Viscosity @ 25 °C	15 000 cP (Mixed) 8 000 cP (A) 16 000 cP (B)	Brookfield Engineering labs Inc. IPCTM-65- Method 2.4.24.4
Mix Ratio	1:1 (Volume) 1:1 (Weight)	_
Working Time <sup>a</sup>	2.5 h	_
Shrinkage	1.6%	Calculated
Shelf Life	5 y	_

<sup>&</sup>lt;sup>a</sup> Based on 100 g sample. Varies by volume and geometry.

## **Cured Properties**

Flame Retardancy	Meets UL 94V-0	_
Color	Black	_
Density	1.6 g/mL	Hydrostatic Weighing
Service Temperature Range	-50–125 °C	_
Intermittent Temperature	-55–165 °C	_
Thermal Conductivity @ 25 °C Specfic Heat Capacity @ 25 °C Thermal Diffusivity @ 25 °C	0.6 W/(m·K) 1.4 J/(g·K) 0.3 mm <sup>2</sup> /s	ASTM E1461
Glass Transition Temperature (Tg)	0.7 °C	ASTM E1545
Coefficient of Thermal Expansion (CTE)	71 ppm/°C (Prior $T_g$ ) 137 ppm/°C (After $T_g$ )	ASTM E831
Hardness	88 A	ASTM D2240
Tensile Strength	5.3 N/mm <sup>2</sup>	ASTM D638
Compressive Strength	21 N/mm <sup>2</sup>	ASTM D695



## **Cured Properties Continued**

Lap Shear	3.7 N/mm <sup>2</sup> (Stainless Steel) 2.7 N/mm <sup>2</sup> (Aluminum) 1.2 N/mm <sup>2</sup> (ABS) 1.6 N/mm <sup>2</sup> (PC)	ASTM D1002
Resistivity	7.5 x 10 <sup>11</sup> Ω-cm	ASTM D257
Breakdown Voltage @ 3.175 mm Dielectric Strength @ 3.175 mm	41 400 V 330 V/mil	ASTM D149
Dielectric Constant @ 1 MHz Dissipation Factor @ 1 MHz	4.5 0.04	ASTM D150
Chemical Absorption Weight Gain, 30 days @ 25 °C	18 % (Acetone) 25 % (Ethyl Acetate) 9 % (IPA) 6 % (Sulphuric Acid 3%) 3 % (10% NaOH) 6 % (10% NaCl) 3 % (Water) 0 % (Transmission Oil) 0.2 % (Transformer Oil) 21 % (Gasoline)	



### **Application Instructions**

Read the product SDS and Application Guide for more detailed instructions before using this product.

#### **Recommended Preparation**

Clean the substrate with 824 99.9% Isopropyl Alcohol, so the surface is free of oils, dust, and other residues.

**Mixing** 

- 1. Scrape settled material free from the bottom and sides of the part A container; stir the contents until homognous. Use a paint shaker if available.
- 2. Measure 1 parts by volume of the part A and pour into the mixing container. Ensure all contents are transferred by scraping the container.
- Measure 1 part by volume of the part B and pour into the mixing container. Ensure all contents are transferred by scraping the container.
- **4.** Thoroughly and gently mix parts A and B together. Avoid introducing air bubbles.
- **5.** To de-air, let sit for 15 minutes or put in a vacuum chamber at 25 inHg for 2 minutes.
- **6.** If bubbles are present at the top, break them gently with the mixing paddle.
- 7. Pour the mixture into a container holding the components to be protected.
- 8. Close the part A and B containers tightly between uses to prevent skinning.

If crystallization/solidification occurs, reconstitute the product by warming to between 55 and 65 °C until it becomes fully re-liquified. Let the material cool to room temperature before mixing, to prevent flash cure.

Mixing >1 kg at a time decreases working time and can lead to a flash cure. Limit the size of hand-mixed batches. For large production volumes, contact MG Chemicals Technical Support for assistance.